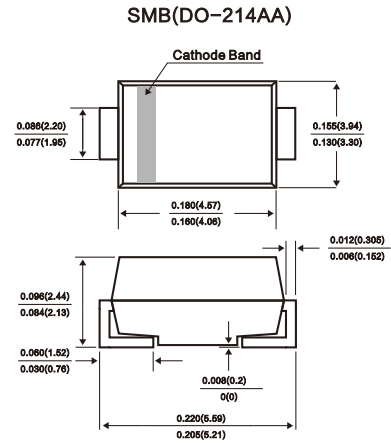


### FEATURES

- Plastic package has Underwriters Laboratory Flammability Classification 94V-0
- Metal silicon junction ,majority carrier conduction
- For surface mount applications
- Low power loss ,high efficiency
- High current capability ,Low forward voltage drop
- Low profile package
- built-in strain relief ,ideal for automated placement
- For use in low voltage ,high frequency inverters, free wheeling ,and polarity protection applications
- High temperature soldering guaranteed:260°C/10 seconds at terminals

### MECHANICAL DATA

- Case: JEDEC SMB(DO-214AA) molded plastic body
- Terminals: solder plated ,solderable per MIL-STD-750,method 2026
- Polarity: color band denotes cathode end
- Weight: 0.003ounce,0.093 gram



Dimensions in inches and (millimeters)

### MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

(Ratings at 25°C ambient temperature unless otherwise specified ,Single phase ,half wave ,resistive or inductive load. For capacitive load,derate by 20%.)

	Symbols	SS 32	SS 33	SS 34	SS 35	SS 36	SS 38	SS 310	SS 315	SS 320	Volts
Maximum repetitive peak reverse voltage	V <sub>RRM</sub>	20	30	40	50	60	80	100	150	200	Volts
Maximum RMS voltage	V <sub>RMS</sub>	14	21	28	35	42	57	71	105	140	Volts
Maximum DC blocking voltage	V <sub>DC</sub>	20	30	40	50	60	80	100	150	200	Volts
Maximum average forward rectified current 0.375"(9.5mm) lead length (See Fig.1)	I(AV)	3.0									Amps
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC method)	I <sub>FSM</sub>	80.0									Amps
Maximum instantaneous forward voltage at 3.0 A(Note 1)	V <sub>F</sub>	0.55			0.75		0.85		0.90	0.95	Volts
Maximum instantaneous reverse current at rated DC blocking voltage(Note 1)	I <sub>R</sub>	0.2									mA
		20			10						
Typical junction capacitance(Note 3)	C <sub>J</sub>	250			160						pF
Typical thermal resistance (Note 2)	R <sub>θJA</sub> R <sub>θJL</sub>	55.0									°C/W
		17.0									
Operating junction temperature range	T <sub>J</sub>	-65 to+150									°C
Storage temperature range	T <sub>STG</sub>	-65 to+150									°C

Notes: 1.Pulse test: 300 μs pulse width,1% duty cycle

2. P.C.B. mounted 0.55 X 0.55"(14 X 14mm)copper pad areas

3. Measured at 1MHz and reverse voltage of 4.0volts

FIG.1-FORWARD CURRENT DERATING CURVE

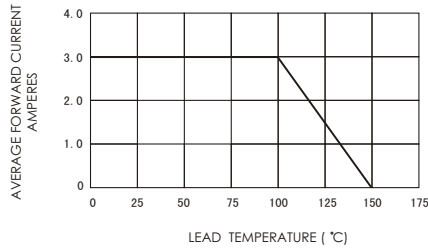


FIG.2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

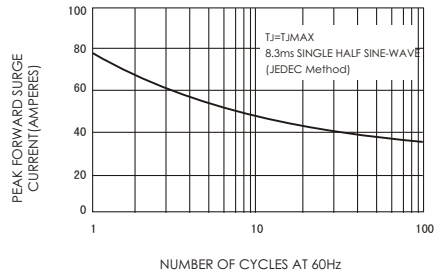


FIG.3-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

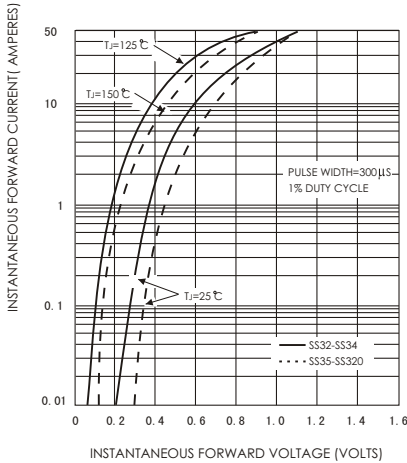


FIG.4-TYPICAL REVERSE CHARACTERISTICS

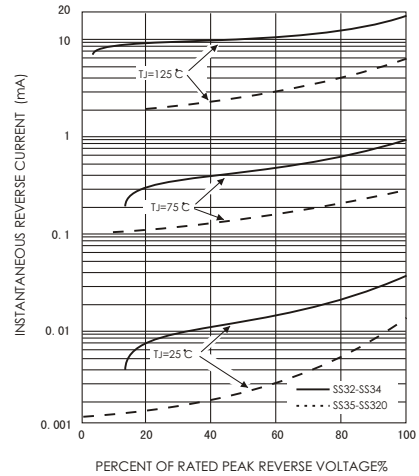


FIG.5-TYPICAL JUNCTION CAPACITANCE

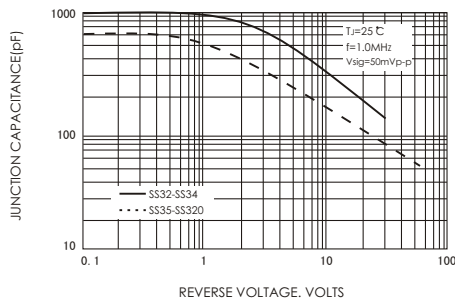
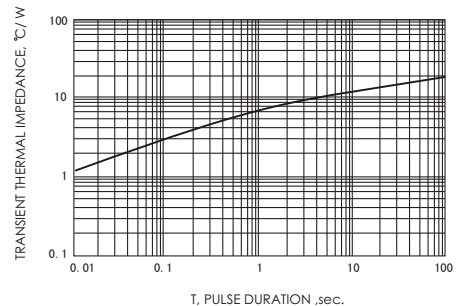


FIG.6-TYPICAL TRANSIENT THERMAL IMPEDANCE



**ORDERING INFORMATION**

<b>Order Code</b>	<b>Package</b>	<b>Baseqty</b>	<b>Deliverymode</b>
SS32	SMB	3000	Tape and reel
SS33	SMB	3000	Tape and reel
SS34	SMB	3000	Tape and reel
SS35	SMB	3000	Tape and reel
SS36	SMB	3000	Tape and reel
SS38	SMB	3000	Tape and reel
SS310	SMB	3000	Tape and reel
SS315	SMB	3000	Tape and reel
SS320	SMB	3000	Tape and reel